## LP5524 Evaluation Kit

National Semiconductor AN-1702 Anssi Raisanen March 17, 2008



## LP5524 Overview

The LP5524 is a highly integrated dual-zone LED driver that can drive up to four LEDs in parallel with a total output current of 100 mA. Regulated high side internal current sources deliver excellent current and brightness matching in all LEDs. Extremely low minimum headroom voltage allows the use of operating voltages that are colse to LED forvard voltages.

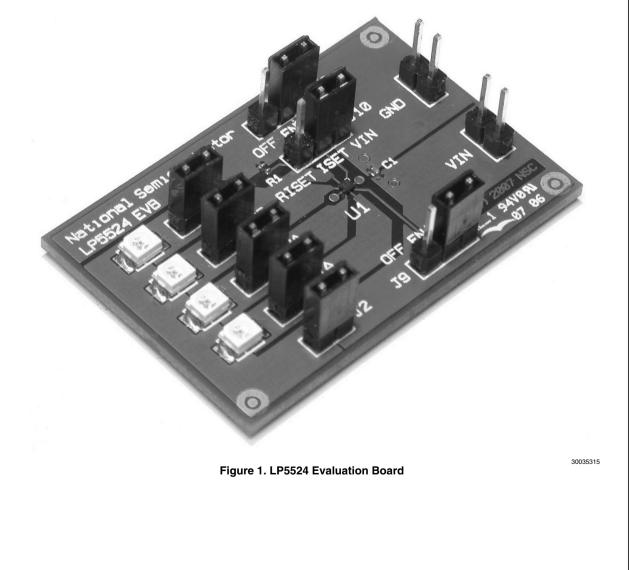
LED driver current sources are split into two independently controlled banks for driving secondary displays, keypads and indicator LEDs. Brightness control is achieved by applying PWM signals to each enable pin. Default LED current is 5mA and an optional external resistor can be used to set initial brightness to user required values. LP5524 is available in National's tiny 9-bump Micro SMD package.

## **Evaluation Kit Overview**

LP5524 Evaluation Kit enables designers an easy way to evaluate the performance of the device. The evaluation board has jumpers for each enable pin for easy on / off type control. These inputs can also be fed with external PWM source. Jumpers on LED outputs allow easy LED current measuring. ISET pin has a jumper for selecting between two LED current levels.

The kit supports complete functional evaluation of the circuit. The evaluation kit consists of:

- LP5524 evaluation board
- LP5524 datasheet
- Evaluation kit document (this doc.)



## **Jumper Description**

This describes the jumpers and the connectors on the LP5524 Evaluation Board.

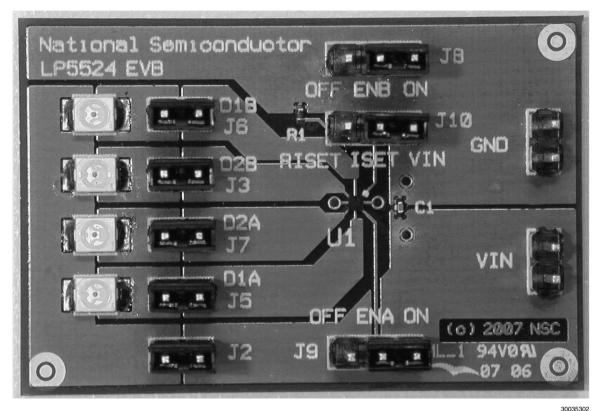


Figure 2. LP5524 Evaluation Board Top View

#### VIN – J1

This connector is the positive input for power supply. Evaluation board can operate with supply voltages from 2.7V to 5.5V. The input leads from power supply should be twisted and kept as short as possible. There is an input capacitor (C1) on board to smooth the input voltage.

#### GND – J4

This is the negative input for power supply.

#### J2

This jumper disconnects all LED cathodes from the GND. This can be used to separate the LED currents from the circuit current.

#### D1B – J6

This jumper can be used to disconnect the D1B output from the LED anode. This can be used to measure the D1B current.

#### D2B - J3

This jumper can be used to disconnect the D2B output from the LED anode. This can be used to measure the D2B current.

#### D2A - J7

This jumper can be used to disconnect the D2A output from the LED anode. This can be used to measure the D2A current.

#### D1A = J5

This jumper can be used to disconnect the D1A output from the LED anode. This can be used to measure the D1A current.

#### D2A – J7

This jumper can be used to disconnect the D2A output from the LED anode. This can be used to measure the D2A current. ENB – J8

This is the ENB input. A three pin connector is applied to allow ENB to be connected either to VIN or to GND. The center pin is connected directly to ENB pin. This pin can be used to connect external PWM signal. Smaller than 300 Hz PWM frequency is recommended.

#### ISET - J10

ISET pin jumper. This can be used to connect the ISET pin either to VIN or to onboard RISET resistor. Connecting ISET to VIN sets the LED current to default 5mA and connecting it to RISET sets the current to 15.6mA. Center pin is connected directly to ISET pin and it can be used to connect external current set resistors.

#### ENA – J9

This is the ENA input. A three pin connector is applied to allow ENA to be connected either to VIN or to GND. The center pin is connected directly to ENA pin. This pin can be used to connect external PWM signal. Smaller than 300 Hz PWM frequency is recommended.

## **Getting Started**

The following instructions show how to set up and use the LP5524 evaluation kit. Please use ESD protection to prevent any unwanted damaging ESD events.

- Check the onboard jumpers. Jumpers on the LED outputs (J3, J5-J7) and the jumper from LED cathodes to gnd (J2) should be on. Remove jumpers from enables (J8 and J9). ISET can be connected either to VDD or RISET.
- 2. Connect evaluation board to a power supply. Check that operation voltage is between 2.7V to 5.5V.
- 3. Set the enable jumpers to ON position. ENA jumper enables drivers D1A and D2A and ENB jumper enables drivers D1B and D2B.
- 4. The Evaluation Kit is now ready to use.

### **Current Measurements**

To measure the current of a single LED driver remove the jumper from that driver's output and connect current meter to jumper's pins. To measure the current of all LEDs remove the J2 jumper and connect current meter to J2 pins. To measure the current consumption of the device separate the LED ground current from the board's ground current by removing the J2 jumper and conecting the LED ground to power supply ground with separated wire. Then connect the current meter to evaluation board's ground wire. Figure 3 illustrates how to measure different currents.

#### **PWM Dimming**

To dim the LEDs feed a proper PWM signal to ENx pin. Less than 300 Hz PWM frequency is recommended. Ensure that PWM signals high and low levels are adequate.

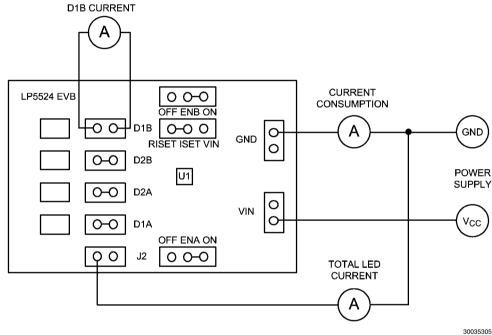


Figure 3. LP5524 Evaluation Board Current Measurements

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## **Board Layout**

A four layer board was used to enable the use of micro-VIAs. Micro VIA is required for routing the center pad of the LP5524. The evaluation board layers are:

- 1. Top, component side, signal
- 2. Layer 2, Vin plane (signal)
- 3. Layer 3, GND plane
- 4. Bottom, GND plane

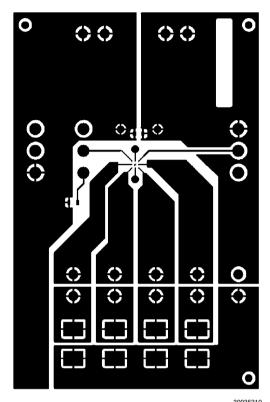


Figure 4. LP5524 Evaluation Board Layer 1 (Top).

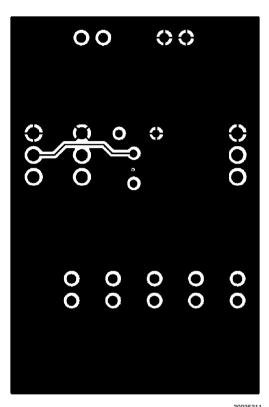
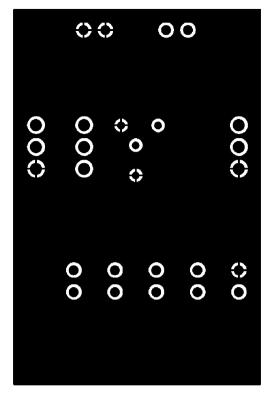


Figure 5. LP5524 Evaluation Board Layer 2.

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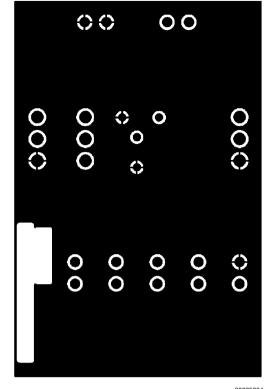


Figure 6. LP5524 Evaluation Board Layer 3.

Figure 7. LP5524 Evaluation Board Layer 4 (Bottom).

## Schematic

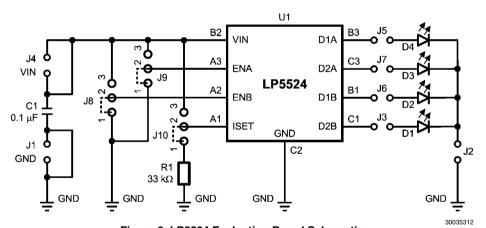


Figure 8. LP5524 Evaluation Board Schematic

## List of Components

Reference	Model	Туре	Vendor	Size
C1	100 nF 10V	Ceramic X5R	TDK	0402 (1005)
R1	<b>33k</b> Ω 1%	-	-	0402 (1005)
D1 -D4	LS T676	LED Red	Osram	3.0 mm x 3.4 mm x 2.1 mm
U1	LP5524	-	NSC	1.215 mm x 1.215 mm x 0.6 mm

## Notes

Pi	oducts	Design Support		
Amplifiers	www.national.com/amplifiers	WEBENCH	www.national.com/webench	
Audio	www.national.com/audio	Analog University	www.national.com/AU	
Clock Conditioners	www.national.com/timing	App Notes	www.national.com/appnotes	
Data Converters	www.national.com/adc	Distributors	www.national.com/contacts	
Displays	www.national.com/displays	Green Compliance	www.national.com/quality/green	
Ethernet	www.national.com/ethernet	Packaging	www.national.com/packaging	
Interface	www.national.com/interface	Quality and Reliability	www.national.com/quality	
LVDS	www.national.com/lvds	Reference Designs	www.national.com/refdesigns	
Power Management	www.national.com/power	Feedback	www.national.com/feedback	
Switching Regulators	www.national.com/switchers			
LDOs	www.national.com/ldo			
LED Lighting	www.national.com/led			
PowerWise	www.national.com/powerwise			
Serial Digital Interface (SDI)	www.national.com/sdi			
Temperature Sensors	www.national.com/tempsensors			
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